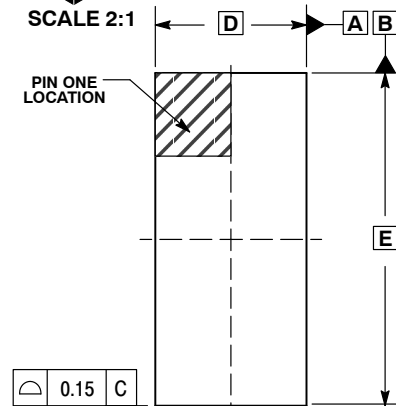
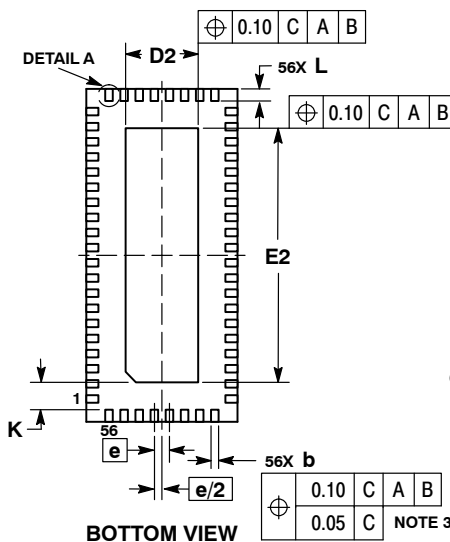
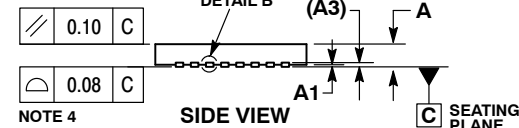
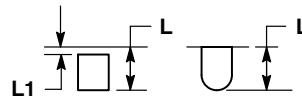
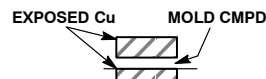
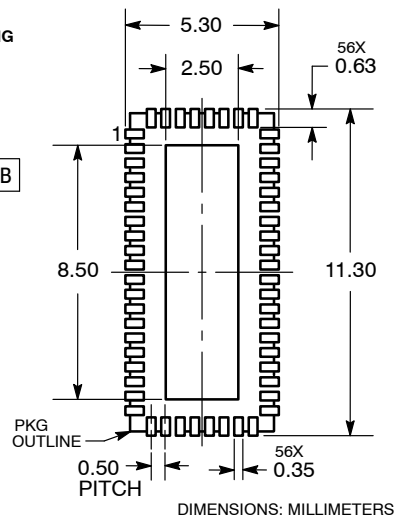
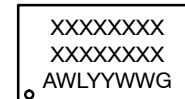

WQFN56 5x11, 0.5P
CASE 510AK
ISSUE A

DATE 02 MAR 2010


TOP VIEW

BOTTOM VIEW

DETAIL A
ALTERNATE
CONSTRUCTIONS

DETAIL B
ALTERNATE
CONSTRUCTION
NOTES:

1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
2. CONTROLLING DIMENSIONS: MILLIMETERS.
3. DIMENSION b APPLIES TO PLATED TERMINAL AND IS MEASURED BETWEEN 0.15 AND 0.30mm FROM THE TERMINAL TIP.
4. COPLANARITY APPLIES TO THE EXPOSED PAD AS WELL AS THE TERMINALS.

MILLIMETERS		
DIM	MIN	MAX
A	0.70	0.80
A1	---	0.05
A3	0.20 REF	
b	0.20	0.30
D	5.00 BSC	
D2	2.30	2.50
E	11.00 BSC	
E2	8.30	8.50
e	0.50 BSC	
K	0.20 MIN	
L	0.30	0.50
L1	---	0.15

RECOMMENDED
SOLDERING FOOTPRINT

GENERIC
MARKING DIAGRAM*


XXXXXX = Specific Device Code
A = Assembly Location
WL = Wafer Lot
YY = Year
WW = Work Week
G = Pb-Free Package

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G", may or not be present.

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